

The UDC universal device carrier module is specially designed for haptics modules such as the THM 1 key haptics module or the DHM 3 rotary haptics modules manufactured by PANOVO tec and can hold up to 3 modules.

The base plate made of sturdy, magnetic stainless steel allows test pieces with even the most complex shapes to be easily clamped using magnetic downholders and strips. The base plate is replaceable, and on request, the carrier can be



supplied with a grooved plate or customised design.

The gap-free linear guides enable the modules to be easily moved up to the test piece without altering the clamping of the test piece.

All connecting leads (network, power supply) are laid in cable carriers with their own power distribution so that the modules can be operated with only one power supply unit.

The integrated network switch means that all the modules can be connected to the analysis computer with a single line.

■ Technical Data

Max. test space (H x W x D)	220x800x500 mm
Travel path X (for all 3 modules)	490 mm
Travel path g Y	250 mm
Travel path Z (from top axis position)	205 mm
Installation space: (HxBxT)	ca. 850x1000x600 mm
Weight:	ca. 60kg
Ambient temperature:	-10 ... 40 °C
Storage-/transport temperature:	-20 ... 60 °C
Rel. Air humidity:	<85 %
Ambient atmosphere:	No corrosive gases, dust, water or oil
Operation Voltage (power supply):	240V 1A 120V/2A
Operatin voltage modules	24V DC 4A
Current input (without modules)	75 mA

■ Dimensions (with mounted modules)

